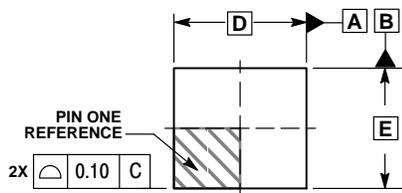


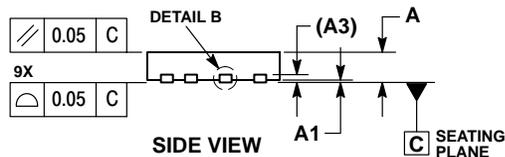
SCALE 4:1

UDFN8 2.2x2, 0.575P
CASE 506CV
ISSUE A

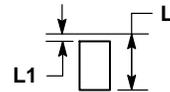
DATE 21 JUL 2015



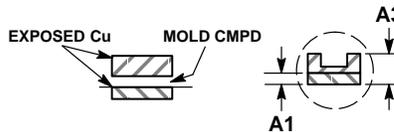
2X 0.10 C
TOP VIEW



SIDE VIEW



DETAIL A
ALTERNATE TERMINAL
CONSTRUCTION



DETAIL B
ALTERNATE
CONSTRUCTIONS

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSIONS b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.25 MM FROM TERMINAL TIP.

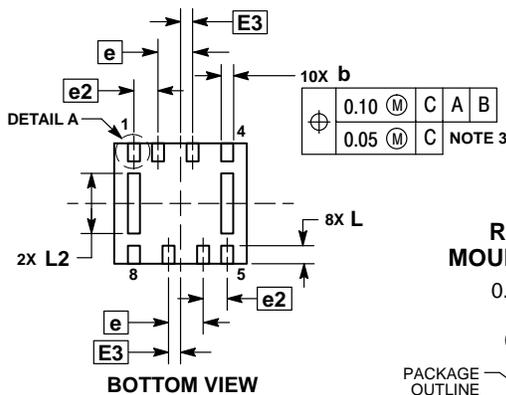
DIM	MILLIMETERS	
	MIN	MAX
A	0.45	0.55
A1	0.00	0.05
A3	0.127 REF	
b	0.15	0.25
D	2.20 BSC	
E	2.00 BSC	
E3	0.20 BSC	
e	0.575 BSC	
e2	0.40 BSC	
L	0.25	0.35
L1	0.05	0.15
L2	0.95	1.05

GENERIC
MARKING DIAGRAM*



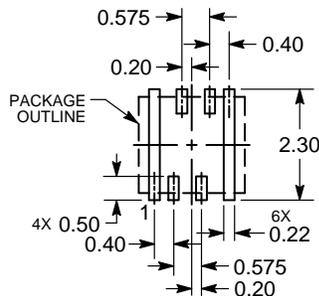
XX = Specific Device Code
M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking.
Pb-Free indicator, "G" or microdot "▪", may or may not be present.



BOTTOM VIEW

RECOMMENDED
MOUNTING FOOTPRINT



DIMENSIONS: MILLIMETERS

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DESCRIPTION:	UDFN8 2.2X2, 0.575P	PAGE 1 OF 1

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